

MA164

Silicon epitaxial planer type

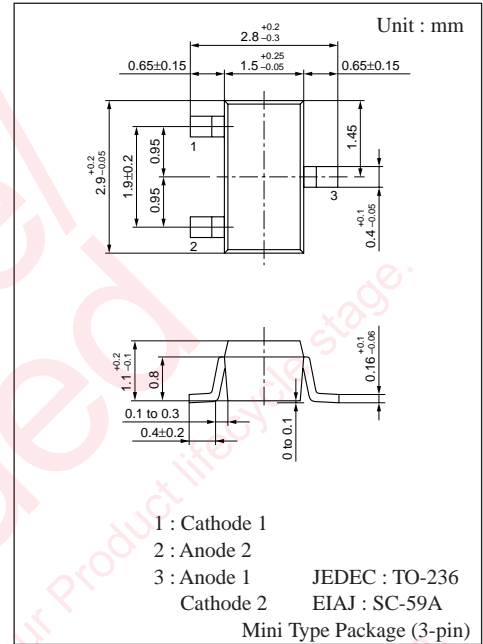
For switching circuits

■ Features

- Independent incorporating of two elements, enabling high-density mounting
- MA153 type with reverse wiring (series connection)

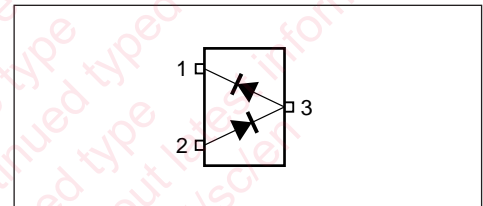
■ Absolute Maximum Ratings (Ta= 25°C)

Parameter	Symbol	Rating	Unit
Reverse voltage (DC)	V_R	40	V
Peak reverse voltage	V_{RM}	40	V
Forward current (DC)	Single	100	mA
	Series	65	
Peak forward current	Single	200	mA
	Series	130	
Junction temperature	T_j	150	°C
Storage temperature	T_{stg}	- 55 to +150	°C



Marking Symbol : M2E

■ Internal Connection



■ Electrical Characteristics (Ta= 25°C)

Parameter	Symbol	Condition	min	typ	max	Unit
Reverse current (DC)	I_R	$V_R = 40V$			100	nA
Forward voltage (DC)	V_F	$I_F = 100mA$			1.2	V
Reverse voltage (DC)	V_R	$I_R = 100\mu A$	40			V
Terminal capacitance	C_t	$V_R = 0V, f = 1MHz$			5	pF
Reverse recovery time	$t_{rr1}^{*1,3}$	$I_F = 10mA, V_R = 6V$		150		ns
	$t_{rr2}^{*2,3}$	$I_{rr} = 0.1 \cdot I_R, R_L = 100\Omega$		9		

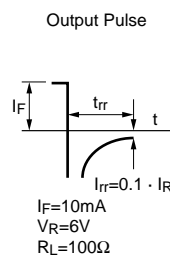
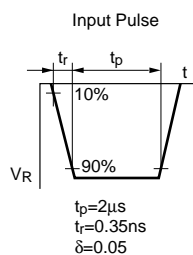
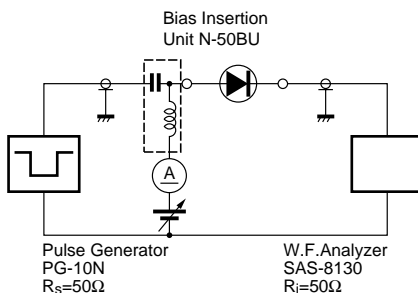
Note 1 : Rated input/output frequency : 100MHz

2 : *1 Between pins 1 and 3

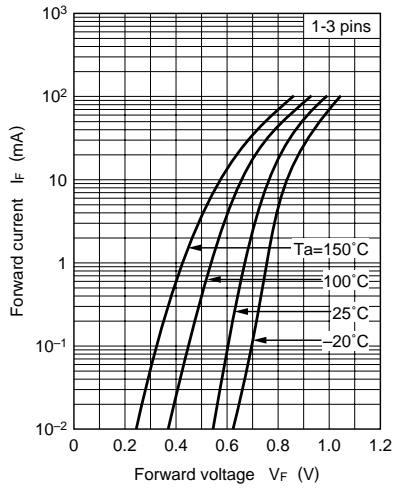
*2 Between pins 2 and 3

*3 t_{rr} measuring circuit

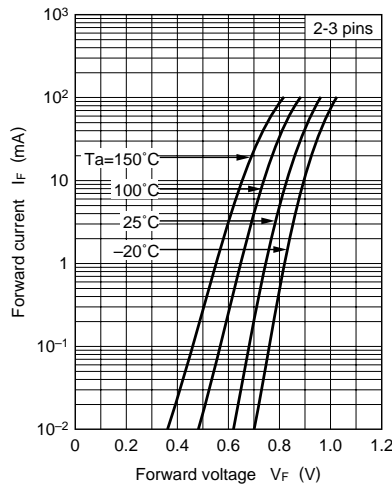
■ Marking



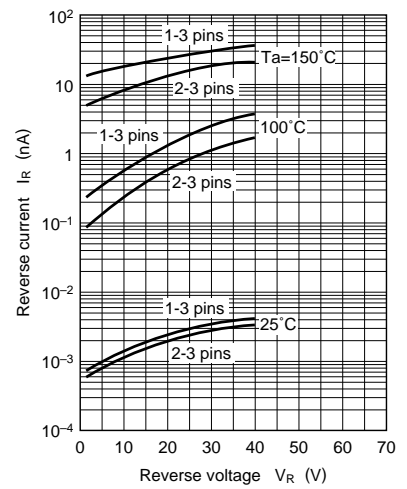
$I_F - V_F$



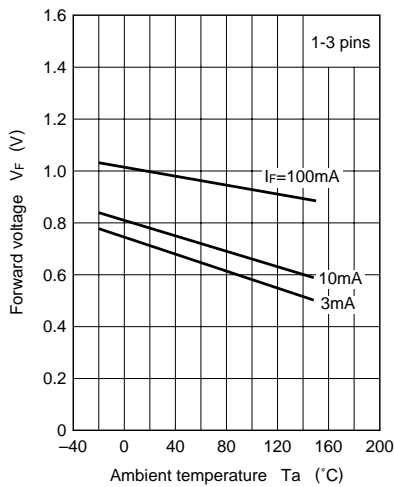
$I_F - V_F$



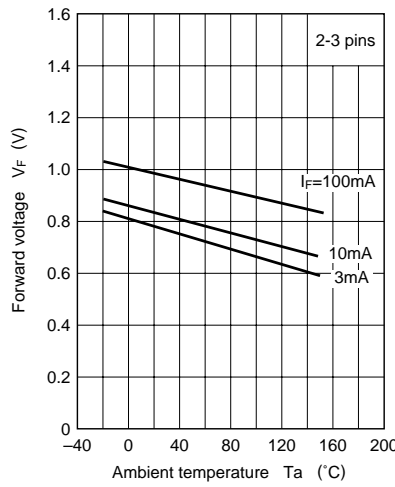
$I_R - V_R$



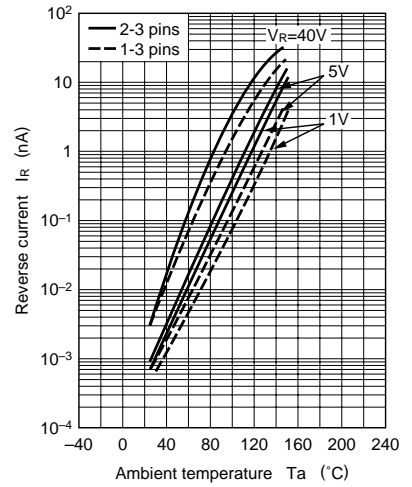
$V_F - T_a$



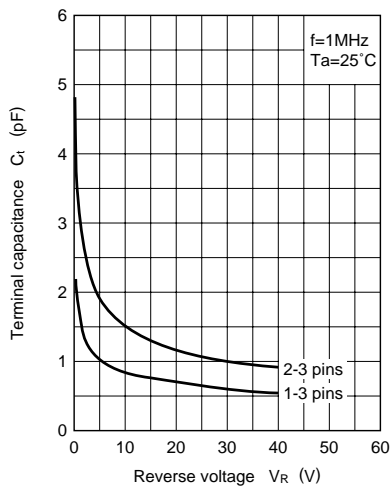
$I_F - T_a$



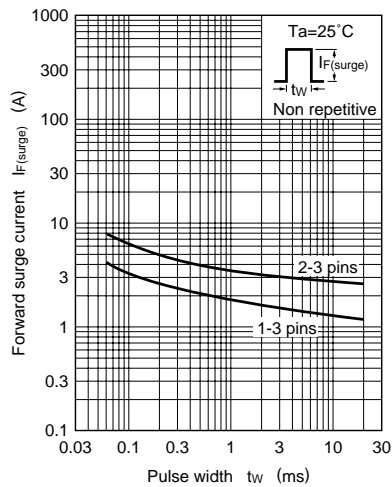
$I_F - T_a$



$C_t - V_R$



$I_F(\text{surge}) - t_w$



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